DOC.NO.: ISS-F06T3.5

INDIVIDUAL SPECIFICATION SHEET

Product Name: 0603 Time Delay SMD Fuse

Part Number: F06T3.5

Revision: B



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Rev.	Effective Date	Changed Contents	
Α	2020-9-27	New Release	
В	2021-4-7	Update Spedfications	

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PREPEARED BY	APPROVED BY
杨崎	AMB



Description

F06T Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.

Rated Current	1.0ln	2.5In
1A~8A	4 hour minimum	5 sec maximum

Features

- High inrush current withstanding capability
- AEC-Q200 Automotive Grade Certified
- Compatible with reflow and wave solder
- Ceramic and glass construction
- Excellent environmental integrity
- > One time positive disconnect
- Lead Free and Halogen free material

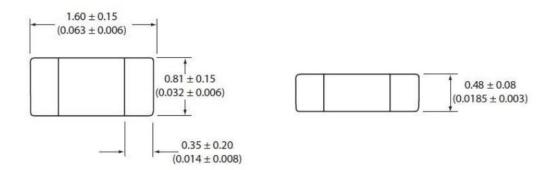
Specifications

Ì	Specification							
	Part No.	Rated Voltage DC	Rated Current (A)	Breaking Capacity (A)	Typical Cold. Resistance (mOhms) ²	Typical Voltage Drop (mV)	Typical Pre- Arcing I ² t (A ² Sec) ³	Alpha Mark
Ì	F06T3.5	32V	3.5	50A	23.8	130	0.5	R

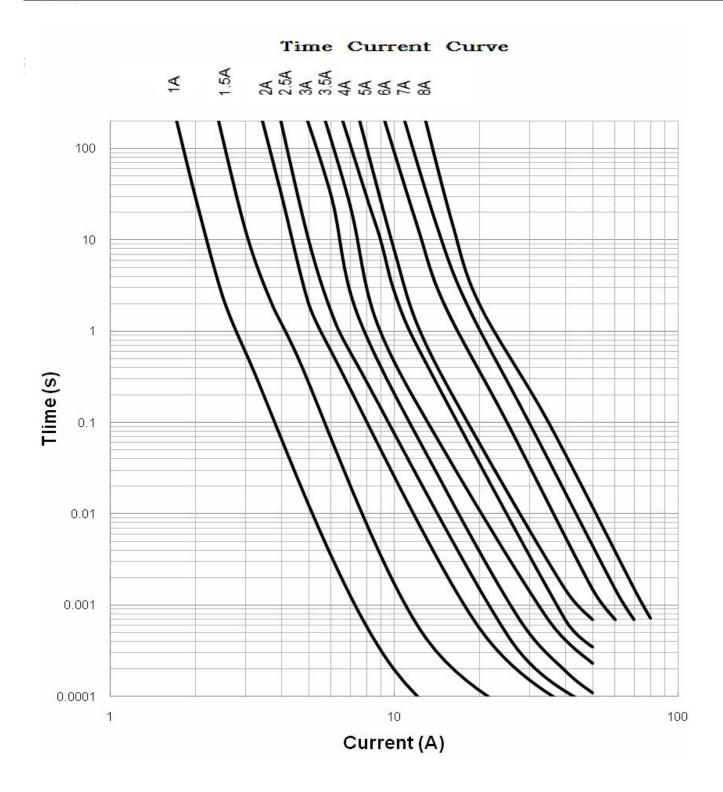
- 1. DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)
- 2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25degrees
- 3. Typical Pre-arcing I²t are measured at 10In Current.

Specifications are subject to change without notice. Application testing is strongly recommended.

Dimension Drawing not to scale (Unit: mm/inch)

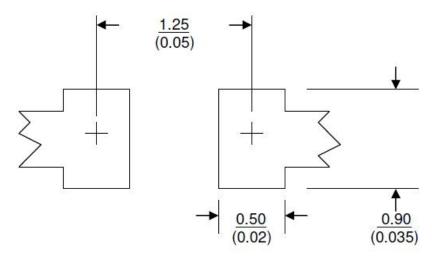








Recommended land pattern



Unit: mm/inches

Soldering method

Wave solder

■ Reservoir temperature: 260°C

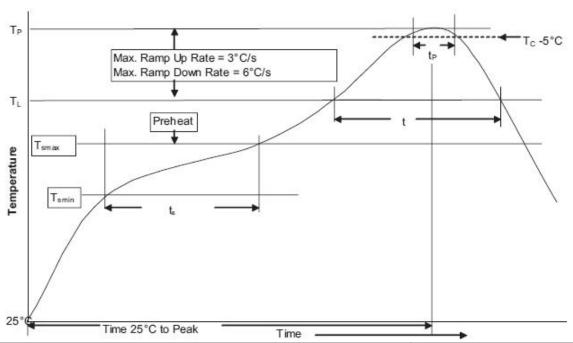
■ Time in reservoir: 10 seconds maximum

> Infrared reflow

■ Temperature: 260°C

■ Time: 30 seconds maximum

Solder reflow profile



Profile Feature		Lead(Pb) free solder
Preheat and soak	Temperature min.(T _{smin})	150°C
	Temperature max. (T _{smax})	200℃

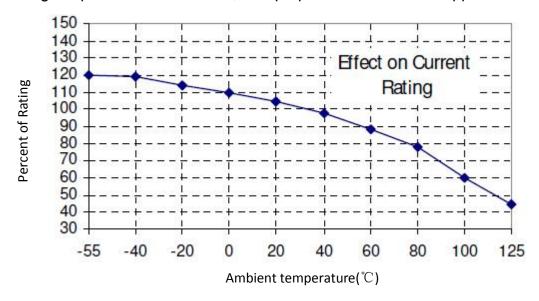


Time (T _{smin} to T _{smax}) (t _S)	60 - 120 Seconds
Average ramp up rate T _{smax} to T _p	3°C / Second Max.
Liquidous temperature (T _L)	217°C
Time at liquidous (t∟)	60 - 150 Seconds
Peak package body temperature (T _P)	260°C
Time (t _P) within 5°C of the specified classification temperature (T _C)	30 Seconds
Average ramp-down rate (T _P to T _{smax})	6°C / Second Max.
Time (25°C to Peak Temperature)	8 Minutes Max.

Temperature Derating Curve

Normal ambient temperature: 23+/-3°C

Operating temperature: -55 ~ 125°C, with proper correction factor applied



Package

5000 fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481.

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